

60V N-Channel Enhancement Mode Power MOSFET

Description

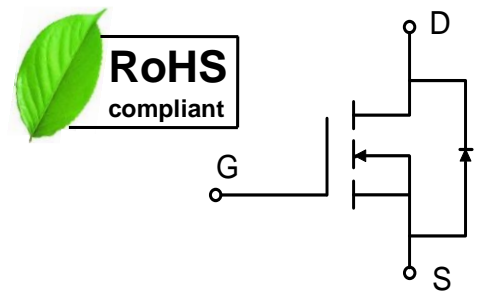
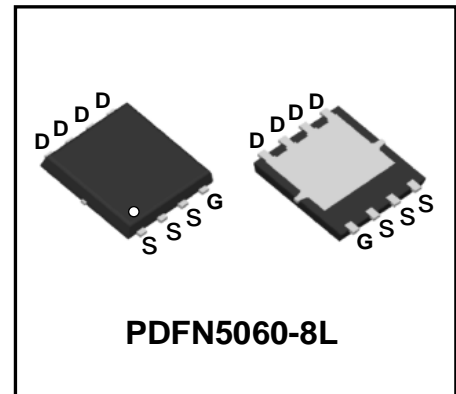
WMB116N06T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- $V_{DS} = 60V$, $I_D = 116A$
 $R_{DS(on)} < 5.2m\Omega @ V_{GS} = 10V$
 $R_{DS(on)} < 7.0m\Omega @ V_{GS} = 4.5V$
- Low $R_{DS(on)}$
- Low Gate Charge
- 100% EAS Guaranteed

Applications

- Power Management Switches
- Synchronous Rectification for AC/DC Quick Charger



Absolute Maximum Ratings

| Parameter | | Symbol | Value | Unit |
|--|---------------------|----------------------|-------------|------------|
| Drain-Source voltage | | V_{DS} | 60 | V |
| Gate-Source voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current@10V ¹ | $T_C = 25^\circ C$ | I_D | 116 | A |
| | $T_C = 100^\circ C$ | | 74 | |
| Pulsed Drain Current ² | | I_{DM} | 250 | A |
| Single Pulse Avalanche Energy ³ | | EAS | 125 | mJ |
| Avalanche Current | | I_{AS} | 50 | A |
| Total Power Dissipation ⁴ | $T_C = 25^\circ C$ | P_D | 113 | W |
| Operating Junction and Storage Temperature Range | | T_J, T_{STG} | -55 to +150 | $^\circ C$ |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|--|-----------------|-------|--------------|
| Thermal Resistance from Junction-to-Ambient ¹ | $R_{\theta JA}$ | 62 | $^\circ C/W$ |
| Thermal Resistance from Junction-to-Case ¹ | $R_{\theta JC}$ | 1.1 | $^\circ C/W$ |

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit | |
|--|------------------------|--|-----------------------------|------|-----------|------------|---------|
| Static Characteristics | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 60 | - | - | V | |
| Gate-body Leakage current | I_{GSS} | $V_{DS} = 0V, V_{GS} = \pm 20V$ | - | - | ± 100 | nA | |
| Zero Gate Voltage Drain Current | $T_J=25^\circ\text{C}$ | I_{DSS} | $V_{DS} = 48V, V_{GS} = 0V$ | - | - | 1 | μA |
| | $T_J=55^\circ\text{C}$ | | | - | - | 5 | |
| Gate-Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 1.2 | - | 2.5 | V | |
| Drain-Source On-Resistance ² | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 15A$ | - | 4.1 | 5.2 | m Ω | |
| | | $V_{GS} = 4.5V, I_D = 10A$ | - | 5.3 | 7 | | |
| Forward Trans conductance | g_{fs} | $V_{DS} = 10V, I_D = 30A$ | - | 75 | - | S | |
| Dynamic Characteristics | | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 15V, V_{GS} = 0V, f = 1\text{MHz}$ | - | 5323 | - | pF | |
| Output Capacitance | C_{oss} | | - | 399 | - | | |
| Reverse Transfer Capacitance | C_{rss} | | - | 325 | - | | |
| Switching Characteristics | | | | | | | |
| Gate Resistance | R_g | $V_{DS} = 0V, V_{GS} = 0V, f = 1\text{MHz}$ | - | 0.7 | - | Ω | |
| Total Gate Charge | Q_g | $V_{GS} = 10V, V_{DS} = 48V, I_D = 25A$ | - | 75 | - | nC | |
| Gate-Source Charge | Q_{gs} | | - | 15.5 | - | | |
| Gate-Drain Charge | Q_{gd} | | - | 20.3 | - | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{GS} = 10V, V_{DD} = 30V$ $R_G = 3.3\Omega, I_D = 30A$ | - | 18.5 | - | nS | |
| Rise Time | t_r | | - | 8.8 | - | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 58.8 | - | | |
| Fall Time | t_f | | - | 15.8 | - | | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Diode Forward Voltage ² | V_{SD} | $I_S = 1A, V_{GS} = 0V$ | - | - | 1.2 | V | |
| Continuous Source Current ^{1,5} | I_S | $V_G = V_D = 0V$, Force Current | - | - | 116 | A | |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 30A, dI/dt = 100A/\mu s$ | - | 22.9 | - | nS | |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 11.6 | - | nC | |

Notes:

- The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- The data tested by pulsed , pulse width $\cong 300\mu s$, duty cycle $\cong 2\%$
- The EAS data shows Max. rating . The test condition is $V_{DD}=50V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=50A$
- The power dissipation is limited by 150°C junction temperature
- The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

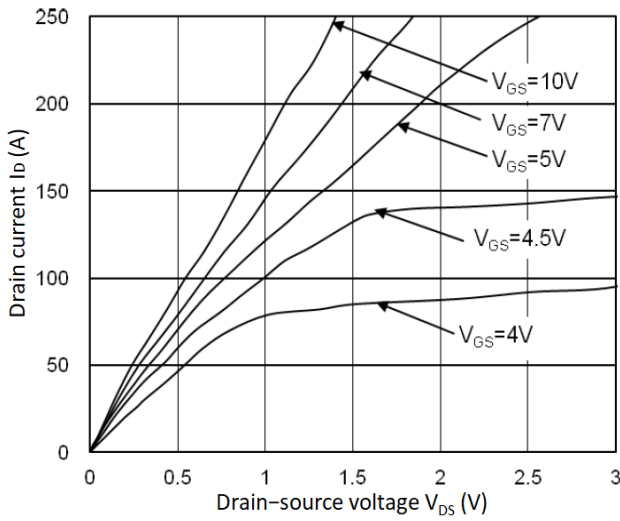


Figure 1. Typical Output Characteristics

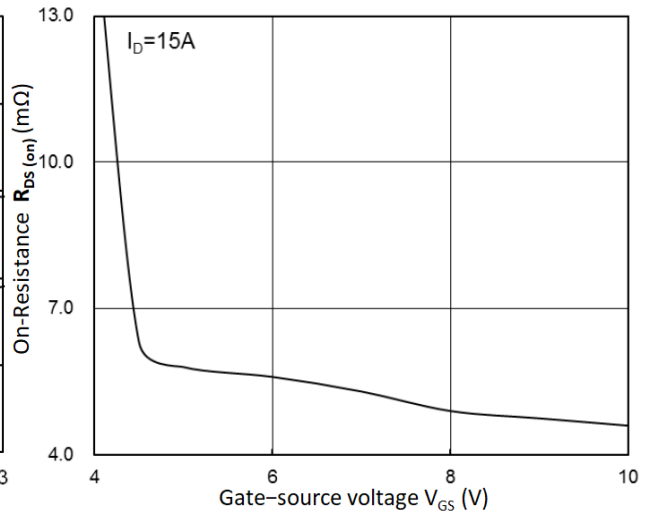


Figure 2. $R_{DS(on)}$ vs. V_{GS}

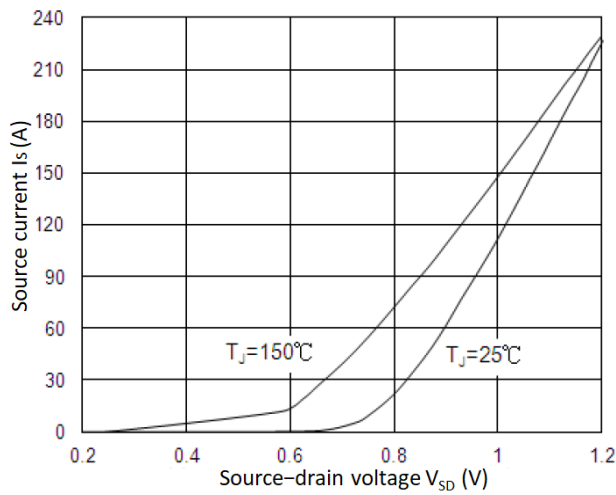


Figure 3. Forward Characteristics Of Reverse

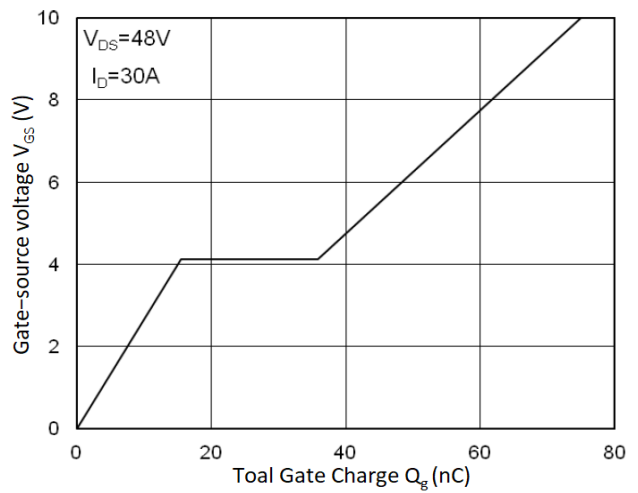


Figure 4. Gate Charge Characteristics

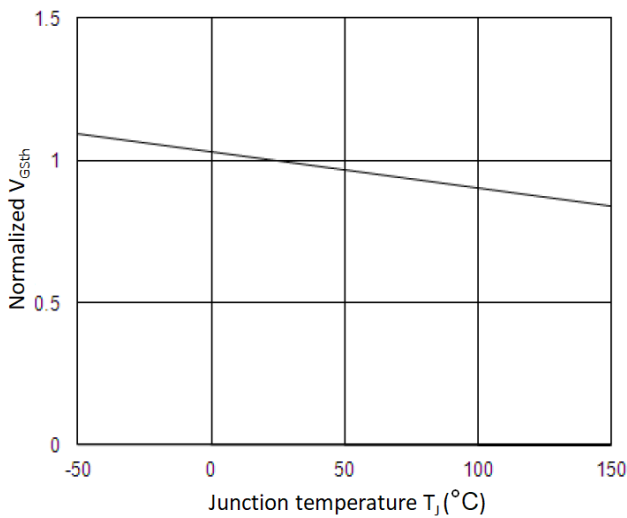


Figure 5. Normalized $V_{GS(th)}$ vs. T_J

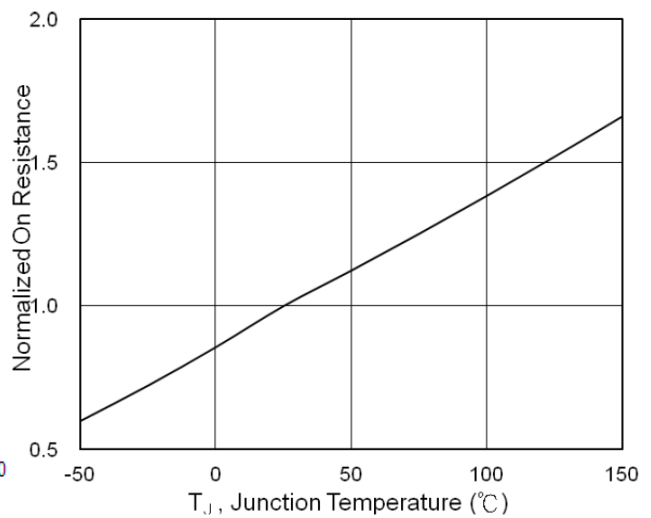


Figure 6. Normalized $R_{DS(on)}$ vs. T_J

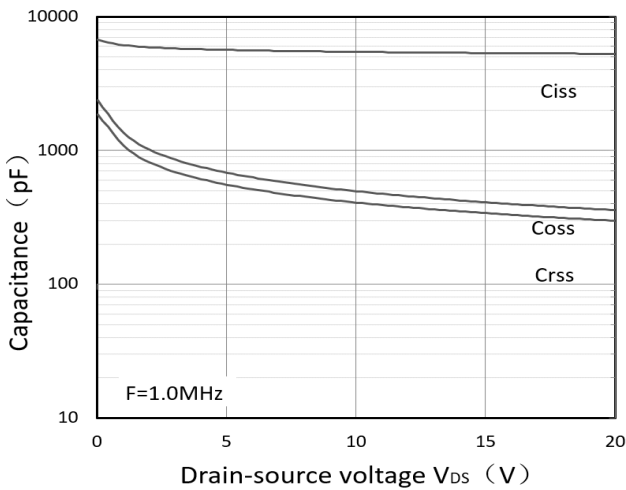


Figure 7. Capacitance

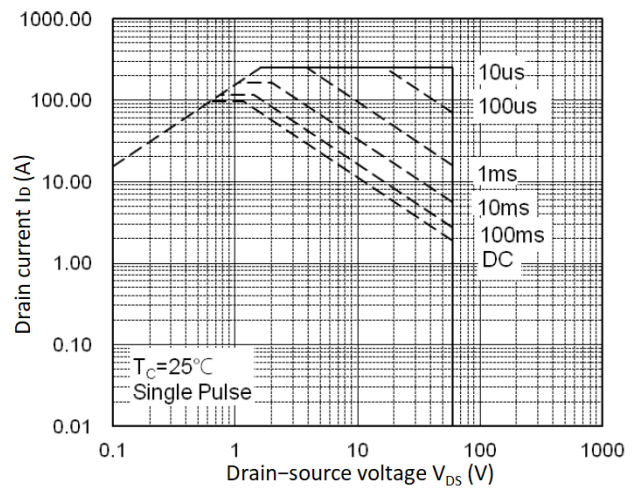


Figure 8. Safe Operating Area

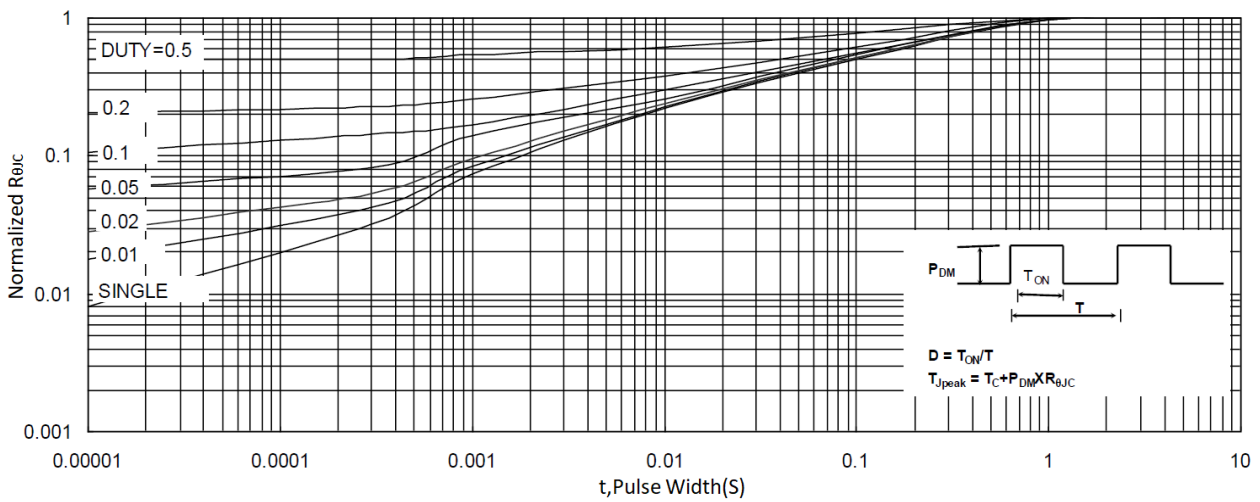


Figure9. Normalized Maximum Transient Thermal Impedance

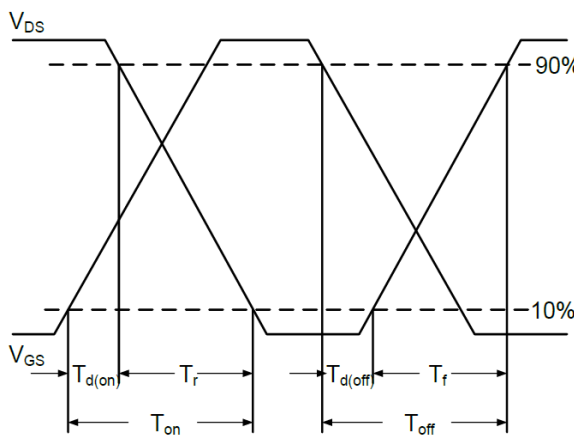
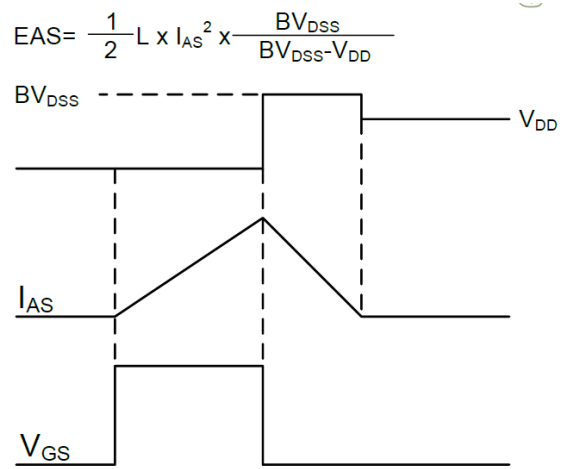


Figure10.Switching Time Waveform

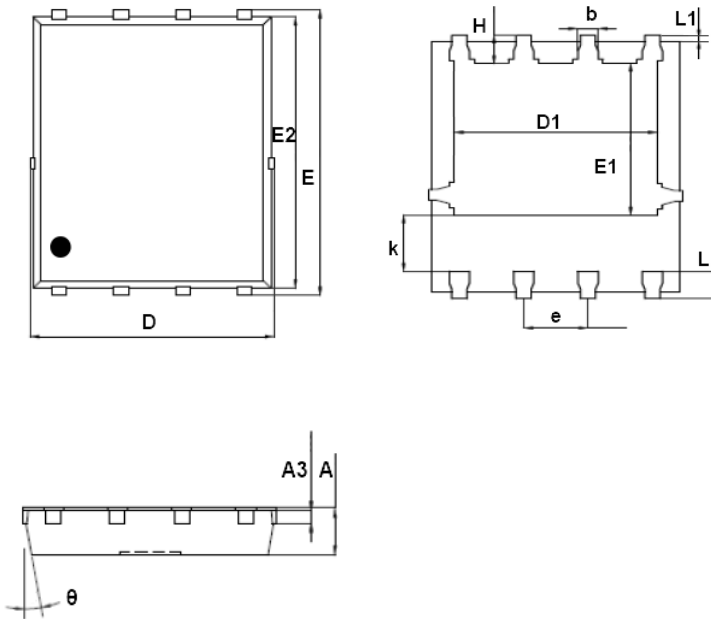


$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

Figure11.Unclamped Inductive Switching Waveform

Mechanical Dimensions for PDFN5060-8L

COMMON DIMENSIONS

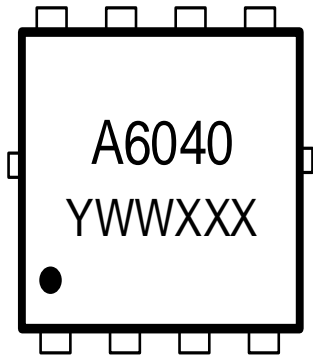


| SYMBOL | MM | |
|----------|---------|------|
| | MIN | MAX |
| A | 0.90 | 1.17 |
| A3 | 0.20 | 0.35 |
| D | 4.80 | 5.40 |
| E | 5.90 | 6.15 |
| D1 | 3.61 | 4.31 |
| E1 | 3.3 | 3.78 |
| E2 | 5.65 | 5.85 |
| k | 1.10 | - |
| b | 0.30 | 0.51 |
| e | 1.27BSC | |
| L | 0.38 | 0.71 |
| L1 | 0.05 | 0.36 |
| H | 0.38 | 0.61 |
| θ | 0° | 12° |

Ordering Information

| Part | Package | Marking | Packing method |
|-------------|-------------|---------|----------------|
| WMB116N06T1 | PDFN5060-8L | A6040 | Tape and Reel |

Marking Information



A6040 = Device code

YWWXXX= Date code

Contact Information

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